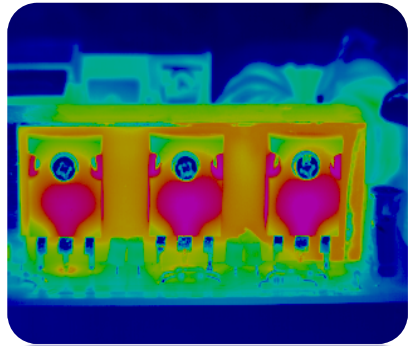


Wireless Charging

Witricity Electric Vehicle Charger



SiC EV Wireless Charging



SiC

High Efficiency

Better Thermal

High Frequency Switching

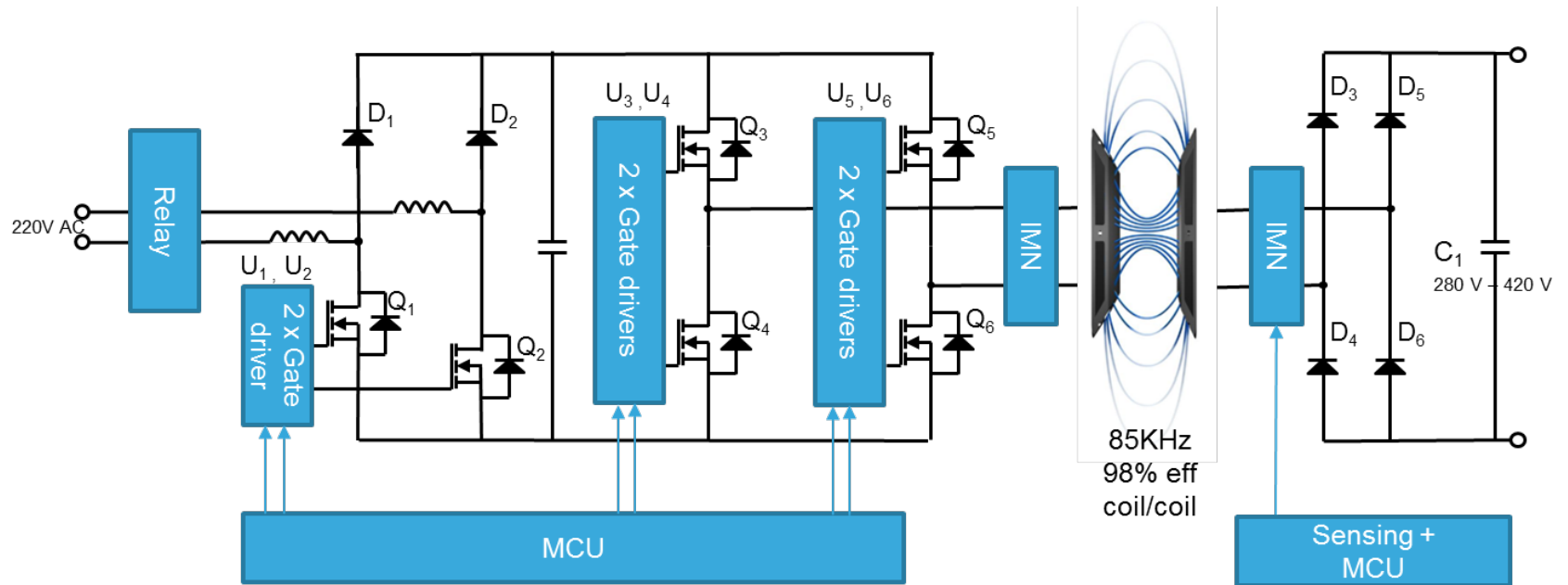
Advanced Topology
for High Efficiency
Power Transfer

Silicon Carbide
MOSFET
Technology

High Current Silicon
Carbide and
Ultrafast Rectifiers

Silicon Carbide
Driving Methods

Advanced Topology for High Efficiency Power Transfer



11kW EV Charging System

| Switch | Part Numbers |
|------------------------|--|
| 2x D1, D2 | STPSC20H065C 650 V power Schottky silicon carbide diode |
| 2x Q1, Q2 | SCTW90N65G2V N-channel 650 V, 0.029 Ohm typ., 90 A SiC MOSFET |
| Q3, Q4, Q5, Q6 | SCTW90N65G2V N-channel 650 V, 0.029 Ohm typ., 90 A SiC MOSFET |
| D3, D4, D5, D6 | STTH30L06WY 30A 600V Fast Rectifiers |
| U1, U2, U3, U4, U5, U6 | TD350 1.5A IGBT, MOSFET advanced gate driver 26V -10V |
| MCU | STM32F405 Cortex M4 |

Automotive Solution



Standards-Compliant



WiTricity wireless EV charging systems are “park-and-charge”

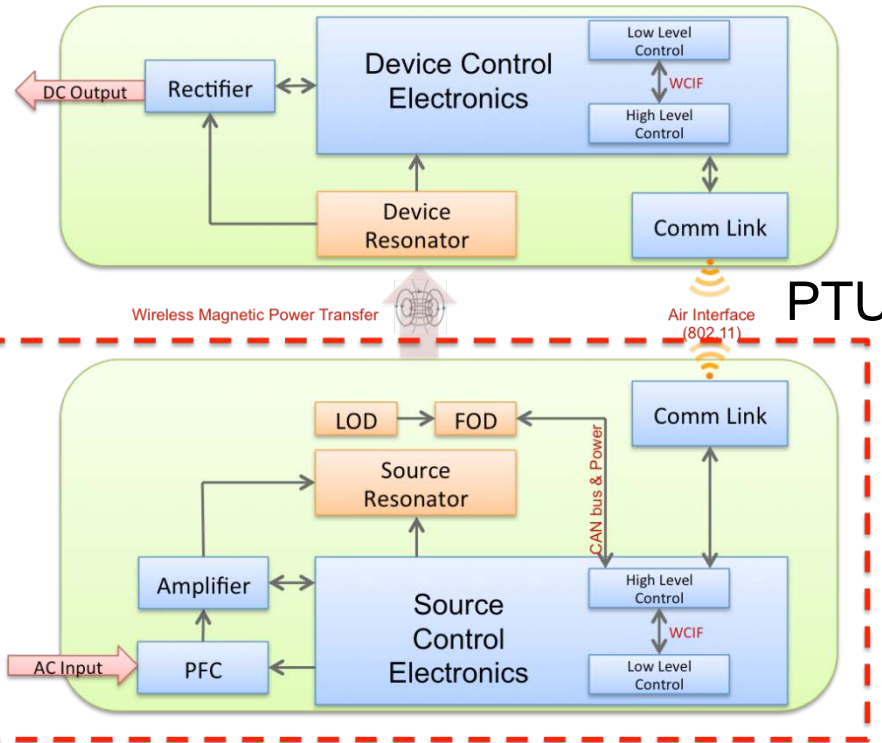
Highlights

- Delivers 3.3kW, 6.6kW, 11kW or more power wirelessly to compatible electric vehicle
- WiTricity is working on wireless charging standards with SAE and other organizations
- Spatial freedom for “park-and-charge” user experience with high efficiency (92%-94%)
- Foreign Object Detection (FOD)

Automotive Solution



Vehicle



PTU

Garage /
Parking Spot

Red box covered by NFPA 70

Specifications

- 3.3kW, 6.6kW and 11kW+ continuously variable ground assembly units (GA)
- Efficiency: Up to 98% coil-to-coil
- Operating Frequency: 85 kHz
- Operating Height: 9 - 28cm vehicle ground clearance
- Communications: WiFi
- Foreign Object Detection: Yes
- Standards: SAE, ISO, IEC pending
- Regulatory: meets FCC, CISPR, ICNIRP guidelines for Emissions and human safety



Silicon Carbide MOSFET Technology

Benefits



Extremely low Power Loss and Low Ron especially at very high Tj

Higher operating frequency for Smaller and lighter systems

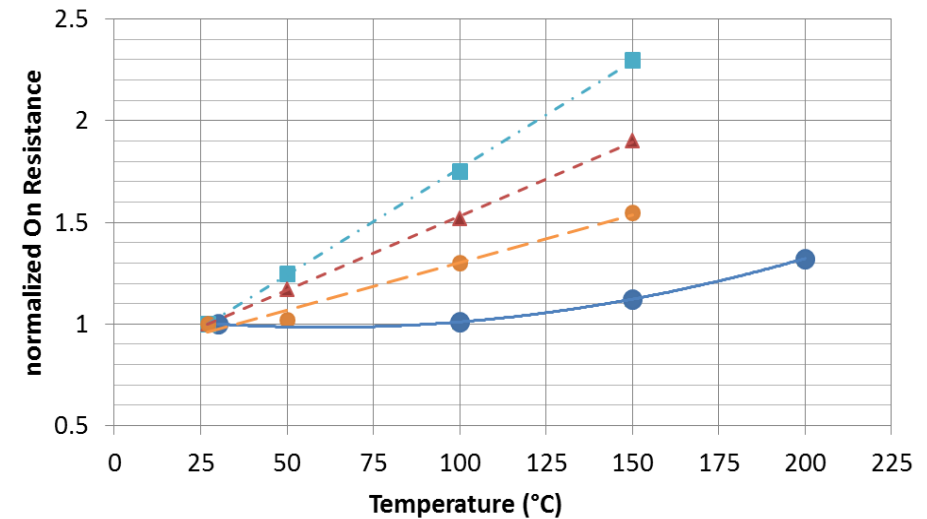
Thermal Performance

High operating temperature ($T_{jmax} = 200^{\circ}C$)

→ Reduced cooling requirements & heat-sink
Increased life time

Easy to Drive

→ Fully compatible with standard Gate Drivers



Silicon Carbide MOSFET Technology

SCTW90N65G2V

- **SCT3W90N65G2V** - SiC Power MOSFET, 90A, 650V, 25mΩ
- **Key parameters:**
 - $V_{BR} > 650V$
 - $I_{ds} = 90A$
 - **$R_{on(typ.)} @ 150^{\circ}C = 29m\Omega$**
 - $Q_{g(typ.)} < 190nC$
 - Gate driving voltage = 20V
 - HiP247™ package → $T_{jmax} = 200^{\circ}C$
- **Key features:**
 - **Very tight variation of on-resistance vs. temperature**
 - Slight variation of switching losses vs. temperature
 - **Very high operating temperature capability (200°C)**
 - Very fast and robust intrinsic body diode
 - Low capacitance
 - Easy to drive
- **Schedule:**
 - **Full Production June 2016**



SCTW90N65G2V

Silicon Carbide Power MOSFET
90A, 650V, 29mΩ (typ. @ $T_j = 150^{\circ}C$)

[Target datasheet](#)

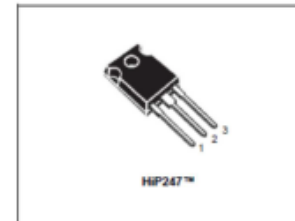
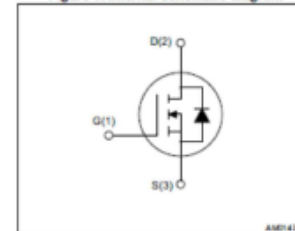


Figure 1. Internal schematic diagram



| Order code | V_{DS} | $R_{on(oss)}$ max. | I_b |
|--------------|----------|--------------------|-------|
| SCTW90N65G2V | 650 V | TBC | 90A |

Features

- Very tight variation of on-resistance vs. Temperature
- Extremely low gate charge and input capacitances
- Very fast and robust intrinsic body diode capacitance
- Very high operating temperature capability ($T_j=200^{\circ}C$)

Applications

Switching applications
Server
High Frequency DC-DC Converters

Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance both almost independent of temperature.



Silicon Carbide Diodes

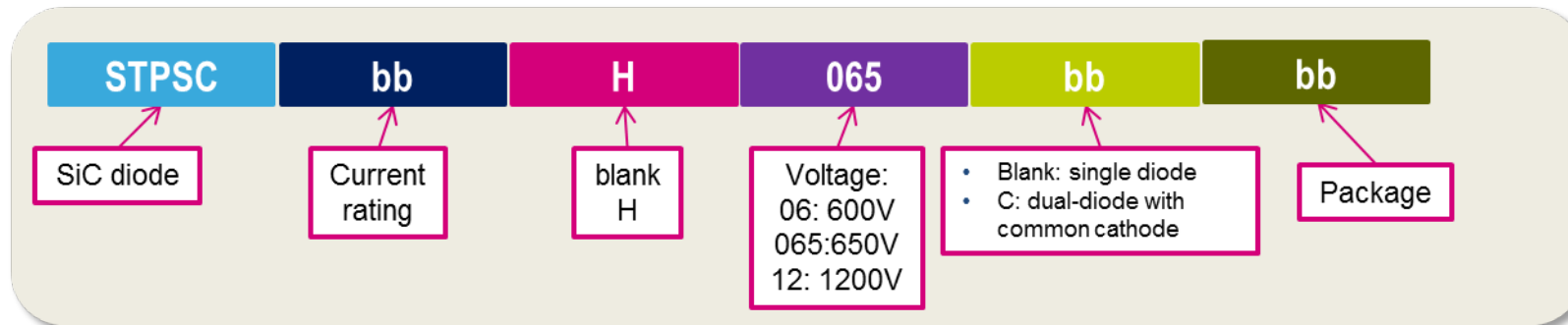


Low switching losses

Best efficiency

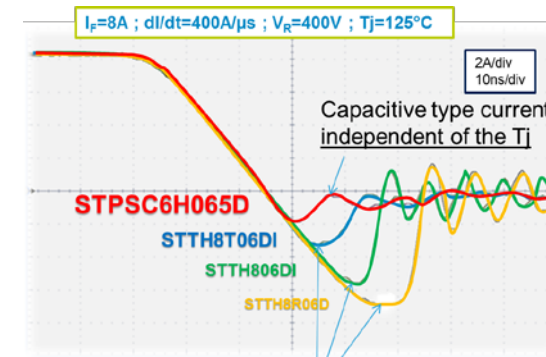
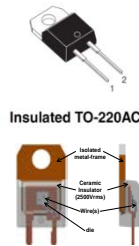
Full Series

600-1200V & AG
High Peak Current – Low Vf



Insulated Packages

Better Thermal - Lower Cost



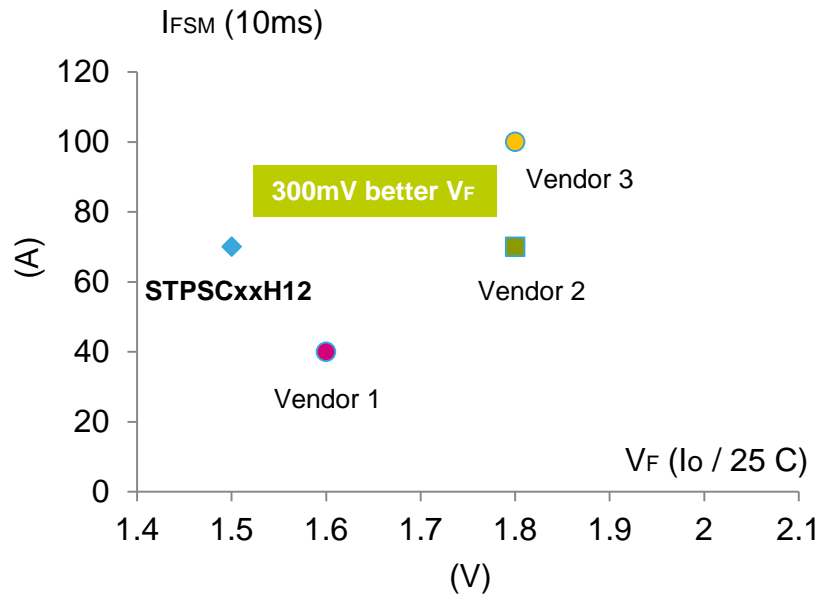
Reverse recovery charges dependent on T_J , di/dt & I_F

New 1200V Silicon Carbide Diodes

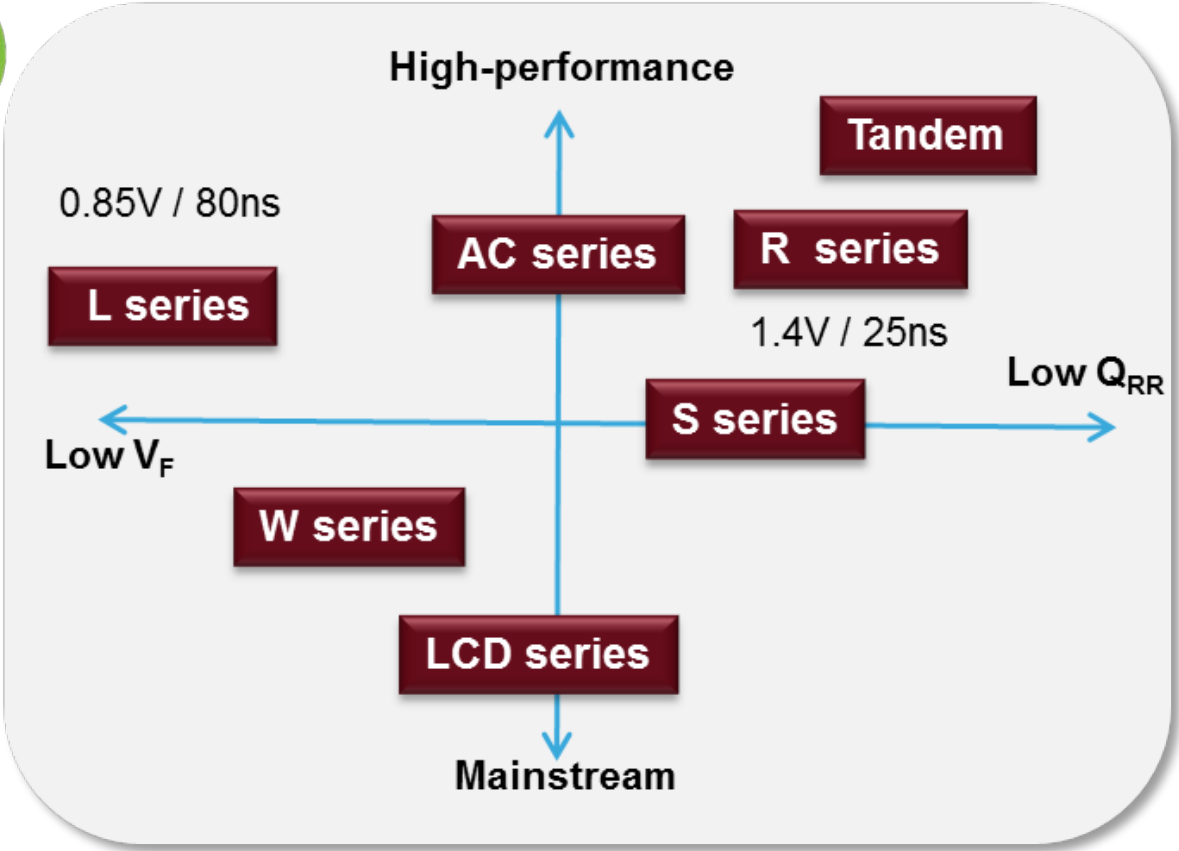


Best in class Forward voltage characteristics

Excellent Robustness with high I_{FSM} level

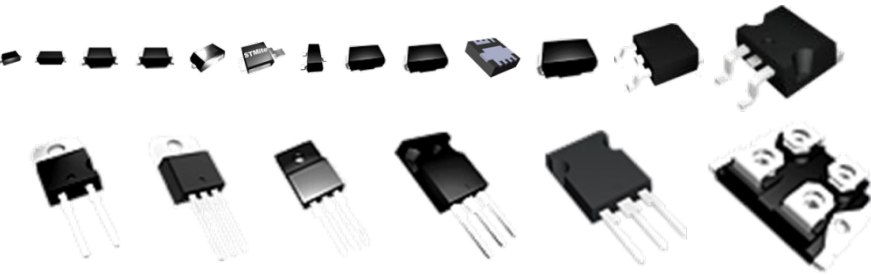


Ultrafast Rectifiers



Pt doped for low leakage (1/100)

STTHxxx 200-1200V, 1-200A, 175°C





Silicon Carbide Driving Methods

- Driving a SiC MOSFET is almost easy as driving a silicon MOSFET:
 - Just need $V_{gs} = 20V$ to get the right R_{on}
 - Adequate current capability to ensure high speed (2-3 A would be the best)
 - Recommended $-4V_{gs}$ drive on turn off to minimize effects of high dv/dt on gate
- Very simple and very mature standard gate drivers can be used
 - ST TD350 + push-pull stage (to increase current capability) in production
 - The new ST isolated GAPdriver: STGAP1S
- An **Application Note** focused on “How to Drive a SiC MOSFET” has been published on st.com.

SiC MOSFET driving circuit

Driving SiC MOSFET with TD350E

The ST **TD350E** is an advanced gate driver for IGBTs and power MOSFETs.

To drive a SiC MOSFET, simply need to add an external push-pull network to increase the current capability. The optimal value of the resistors of the push/pull stage (R_{G-on} & R_{G-off}) are between $2.2\Omega/6.8\Omega$ according to dv/dt requirements.

